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Kind regards,

Team Nexperia

# 74HC2G125; 74HCT2G125

Dual buffer/line driver; 3-state

Rev. 5 — 17 March 2014

Product data sheet

## 1. General description

The 74HC2G125; 74HCT2G125 are dual buffer/line drivers with 3-state outputs controlled by the output enable inputs ( $\overline{\text{OE}}$ ). Inputs include clamp diodes which enable the use of current limiting resistors to interface inputs to voltages in excess of  $V_{\text{CC}}$ .

## 2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- Input levels:
  - ◆ For 74HC2G125: CMOS level
  - ◆ For 74HCT2G125: TTL level
- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$

## 3. Ordering information

Table 1. Ordering information

| Type number  | Package                                                         |        |                                                                                                             |          |
|--------------|-----------------------------------------------------------------|--------|-------------------------------------------------------------------------------------------------------------|----------|
|              | Temperature range                                               | Name   | Description                                                                                                 | Version  |
| 74HC2G125DP  | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm                     | SOT505-2 |
| 74HCT2G125DP |                                                                 |        |                                                                                                             |          |
| 74HC2G125DC  | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm                                  | SOT765-1 |
| 74HCT2G125DC |                                                                 |        |                                                                                                             |          |
| 74HC2G125GD  | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | XSON8  | plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5\text{ mm}$ | SOT996-2 |
| 74HCT2G125GD |                                                                 |        |                                                                                                             |          |



4. Marking

Table 2. Marking codes

| Type number  | Marking code <sup>[1]</sup> |
|--------------|-----------------------------|
| 74HC2G125DP  | H25                         |
| 74HCT2G125DP | T25                         |
| 74HC2G125DC  | H25                         |
| 74HCT2G125DC | T25                         |
| 74HC2G125GD  | H25                         |
| 74HCT2G125GD | T25                         |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

mce185

Fig 1. Logic symbol

mce186

Fig 2. IEC logic symbol

mna120

Fig 3. Logic diagram (one driver)

6. Pinning information

6.1 Pinning

001aae074

Fig 4. Pin configuration SOT505-2 (TSSOP8) and SOT765-1 (VSSOP8)

001aai333

Transparent top view

Fig 5. Pin configuration SOT996-2 (XSON8)

## 6.2 Pin description

Table 3. Pin description

| Symbol                           | Pin  | Description                      |
|----------------------------------|------|----------------------------------|
| $\overline{1OE}, \overline{2OE}$ | 1, 7 | output enable input (active LOW) |
| 1A, 2A                           | 2, 5 | data input                       |
| GND                              | 4    | ground (0 V)                     |
| 1Y, 2Y                           | 6, 3 | data output                      |
| V <sub>CC</sub>                  | 8    | supply voltage                   |

## 7. Functional description

Table 4. Function table<sup>[1]</sup>

| Control          | Input | Output |
|------------------|-------|--------|
| $\overline{nOE}$ | nA    | nY     |
| L                | L     | L      |
| L                | H     | H      |
| H                | X     | Z      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions                                                                         | Min  | Max  | Unit |
|------------------|-------------------------|------------------------------------------------------------------------------------|------|------|------|
| V <sub>CC</sub>  | supply voltage          |                                                                                    | -0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V or V <sub>I</sub> > V <sub>CC</sub> + 0.5 V <sup>[1]</sup> | -    | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < -0.5 V or V <sub>O</sub> > V <sub>CC</sub> + 0.5 V <sup>[1]</sup> | -    | ±20  | mA   |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = -0.5 V to (V <sub>CC</sub> + 0.5 V) <sup>[1]</sup>                | -    | 35   | mA   |
| I <sub>CC</sub>  | supply current          |                                                                                    | -    | 70   | mA   |
| I <sub>GND</sub> | ground current          |                                                                                    | -70  | -    | mA   |
| T <sub>stg</sub> | storage temperature     |                                                                                    | -65  | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> = -40 °C to +125 °C <sup>[2]</sup>                                | -    | 300  | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K.  
 For VSSOP8 package: above 110 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.  
 For XSON8 package: above 45 °C the value of P<sub>tot</sub> derates linearly with 2.4 mW/K.

## 9. Recommended operating conditions

**Table 6. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                           | Conditions              | 74HC2G125 |      |                 | 74HCT2G125 |      |                 | Unit |
|---------------------|-------------------------------------|-------------------------|-----------|------|-----------------|------------|------|-----------------|------|
|                     |                                     |                         | Min       | Typ  | Max             | Min        | Typ  | Max             |      |
| V <sub>CC</sub>     | supply voltage                      |                         | 2.0       | 5.0  | 6.0             | 4.5        | 5.0  | 5.5             | V    |
| V <sub>I</sub>      | input voltage                       |                         | 0         | -    | V <sub>CC</sub> | 0          | -    | V <sub>CC</sub> | V    |
| V <sub>O</sub>      | output voltage                      |                         | 0         | -    | V <sub>CC</sub> | 0          | -    | V <sub>CC</sub> | V    |
| T <sub>amb</sub>    | ambient temperature                 |                         | -40       | +25  | +125            | -40        | +25  | +125            | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | V <sub>CC</sub> = 2.0 V | -         | -    | 625             | -          | -    | -               | ns/V |
|                     |                                     | V <sub>CC</sub> = 4.5 V | -         | 1.67 | 139             | -          | 1.67 | 139             | ns/V |
|                     |                                     | V <sub>CC</sub> = 6.0 V | -         | -    | 83              | -          | -    | -               | ns/V |

## 10. Static characteristics

**Table 7. Static characteristics**

Voltages are referenced to GND (ground = 0 V). All typical values are measured at T<sub>amb</sub> = 25 °C.

| Symbol          | Parameter                 | Conditions                                                                                                                | T <sub>amb</sub> = −40 °C to +85 °C |      |      | T <sub>amb</sub> = −40 °C to +125 °C |      | Unit |
|-----------------|---------------------------|---------------------------------------------------------------------------------------------------------------------------|-------------------------------------|------|------|--------------------------------------|------|------|
|                 |                           |                                                                                                                           | Min                                 | Typ  | Max  | Min                                  | Max  |      |
| 74HC2G125       |                           |                                                                                                                           |                                     |      |      |                                      |      |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V                                                                                                   | 1.5                                 | 1.2  | -    | 1.5                                  | -    | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V                                                                                                   | 3.15                                | 2.4  | -    | 3.15                                 | -    | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V                                                                                                   | 4.2                                 | 3.2  | -    | 4.2                                  | -    | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V                                                                                                   | -                                   | 0.8  | 0.5  | -                                    | 0.5  | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V                                                                                                   | -                                   | 2.1  | 1.35 | -                                    | 1.35 | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V                                                                                                   | -                                   | 2.8  | 1.8  | -                                    | 1.8  | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                                       |                                     |      |      |                                      |      |      |
|                 |                           | I <sub>O</sub> = −20 μA; V <sub>CC</sub> = 2.0 V                                                                          | 1.9                                 | 2.0  | -    | 1.9                                  | -    | V    |
|                 |                           | I <sub>O</sub> = −20 μA; V <sub>CC</sub> = 4.5 V                                                                          | 4.4                                 | 4.5  | -    | 4.4                                  | -    | V    |
|                 |                           | I <sub>O</sub> = −20 μA; V <sub>CC</sub> = 6.0 V                                                                          | 5.9                                 | 6.0  | -    | 5.9                                  | -    | V    |
|                 |                           | I <sub>O</sub> = −6.0 mA; V <sub>CC</sub> = 4.5 V                                                                         | 3.84                                | 4.32 | -    | 3.7                                  | -    | V    |
| V <sub>OL</sub> | LOW-level output voltage  | I <sub>O</sub> = −7.8 mA; V <sub>CC</sub> = 6.0 V                                                                         | 5.34                                | 5.81 | -    | 5.2                                  | -    | V    |
|                 |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                                       |                                     |      |      |                                      |      |      |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V                                                                           | -                                   | 0    | 0.1  | -                                    | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V                                                                           | -                                   | 0    | 0.1  | -                                    | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V                                                                           | -                                   | 0    | 0.1  | -                                    | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V                                                                          | -                                   | 0.15 | 0.33 | -                                    | 0.4  | V    |
| I <sub>I</sub>  | input leakage current     | I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V                                                                          | -                                   | 0.16 | 0.33 | -                                    | 0.4  | V    |
|                 |                           | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V                                                          | -                                   | -    | ±1.0 | -                                    | ±1.0 | μA   |
| I <sub>OZ</sub> | OFF-state output current  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>V <sub>O</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V | -                                   | -    | ±5.0 | -                                    | ±10  | μA   |

**Table 7.** Static characteristics ...continued

Voltages are referenced to GND (ground = 0 V). All typical values are measured at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .

| Symbol            | Parameter                 | Conditions                                                                                                  | $T_{amb} = -40\text{ }^{\circ}\text{C to } +85\text{ }^{\circ}\text{C}$ |      |           | $T_{amb} = -40\text{ }^{\circ}\text{C to } +125\text{ }^{\circ}\text{C}$ |           | Unit          |
|-------------------|---------------------------|-------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|------|-----------|--------------------------------------------------------------------------|-----------|---------------|
|                   |                           |                                                                                                             | Min                                                                     | Typ  | Max       | Min                                                                      | Max       |               |
| $I_{CC}$          | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$ ;<br>$V_{CC} = 6.0\text{ V}$                                      | -                                                                       | -    | 10        | -                                                                        | 20        | $\mu\text{A}$ |
| $C_I$             | input capacitance         |                                                                                                             | -                                                                       | 1.0  | -         | -                                                                        | -         | pF            |
| $C_O$             | output capacitance        |                                                                                                             | -                                                                       | 1.5  | -         | -                                                                        | -         | pF            |
| <b>74HCT2G125</b> |                           |                                                                                                             |                                                                         |      |           |                                                                          |           |               |
| $V_{IH}$          | HIGH-level input voltage  | $V_{CC} = 4.5\text{ V to } 5.5\text{ V}$                                                                    | 2.0                                                                     | 1.6  | -         | 2.0                                                                      | -         | V             |
| $V_{IL}$          | LOW-level input voltage   | $V_{CC} = 4.5\text{ V to } 5.5\text{ V}$                                                                    | -                                                                       | 1.2  | 0.8       | -                                                                        | 0.8       | V             |
| $V_{OH}$          | HIGH-level output voltage | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5\text{ V}$                                                        |                                                                         |      |           |                                                                          |           |               |
|                   |                           | $I_O = -20\text{ }\mu\text{A}$                                                                              | 4.4                                                                     | 4.5  | -         | 4.4                                                                      | -         | V             |
|                   |                           | $I_O = -6.0\text{ mA}$                                                                                      | 3.84                                                                    | 4.32 | -         | 3.7                                                                      | -         | V             |
| $V_{OL}$          | LOW-level output voltage  | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5\text{ V}$                                                        |                                                                         |      |           |                                                                          |           |               |
|                   |                           | $I_O = 20\text{ }\mu\text{A}$                                                                               | -                                                                       | 0    | 0.1       | -                                                                        | 0.1       | V             |
|                   |                           | $I_O = 6.0\text{ mA}$                                                                                       | -                                                                       | 0.16 | 0.33      | -                                                                        | 0.4       | V             |
| $I_I$             | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5\text{ V}$                                                              | -                                                                       | -    | $\pm 1.0$ | -                                                                        | $\pm 1.0$ | $\mu\text{A}$ |
| $I_{OZ}$          | OFF-state output current  | $V_I = V_{IH}$ or $V_{IL}$ ;<br>$V_O = V_{CC}$ or GND; $V_{CC} = 5.5\text{ V}$                              | -                                                                       | -    | $\pm 5.0$ | -                                                                        | $\pm 10$  | $\mu\text{A}$ |
| $I_{CC}$          | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$ ;<br>$V_{CC} = 5.5\text{ V}$                                      | -                                                                       | -    | 10        | -                                                                        | 20        | $\mu\text{A}$ |
| $\Delta I_{CC}$   | additional supply current | per input; $V_{CC} = 4.5\text{ V to } 5.5\text{ V}$ ;<br>$V_I = V_{CC} - 2.1\text{ V}$ ; $I_O = 0\text{ A}$ | -                                                                       | -    | 375       | -                                                                        | 410       | $\mu\text{A}$ |
| $C_I$             | input capacitance         |                                                                                                             | -                                                                       | 1.0  | -         | -                                                                        | -         | pF            |
| $C_O$             | output capacitance        |                                                                                                             | -                                                                       | 1.5  | -         | -                                                                        | -         | pF            |

## 11. Dynamic characteristics

**Table 8.** Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $C_L = 50\text{ pF}$  unless otherwise specified; for test circuit see [Figure 8](#).

| Symbol          | Parameter         | Conditions                                            | T <sub>amb</sub> = −40 °C to +85 °C |                    |     | T <sub>amb</sub> = −40 °C to +125 °C |     | Unit |
|-----------------|-------------------|-------------------------------------------------------|-------------------------------------|--------------------|-----|--------------------------------------|-----|------|
|                 |                   |                                                       | Min                                 | Typ <sup>[1]</sup> | Max | Min                                  | Max |      |
| 74HC2G125       |                   |                                                       |                                     |                    |     |                                      |     |      |
| t <sub>pd</sub> | propagation delay | nA to nY; see <a href="#">Figure 6</a> <sup>[2]</sup> |                                     |                    |     |                                      |     |      |
|                 |                   | V <sub>CC</sub> = 2.0 V                               | -                                   | 35                 | 115 | -                                    | 135 | ns   |
|                 |                   | V <sub>CC</sub> = 4.5 V                               | -                                   | 11                 | 23  | -                                    | 27  | ns   |
|                 |                   | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF       | -                                   | 10                 | -   | -                                    | -   | ns   |
|                 |                   | V <sub>CC</sub> = 6.0 V                               | -                                   | 8                  | 20  | -                                    | 23  | ns   |

**Table 8. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit see [Figure 8](#).

| Symbol           | Parameter                     | Conditions                                                                                            | T <sub>amb</sub> = −40 °C to +85 °C |                    |     | T <sub>amb</sub> = −40 °C to +125 °C |     | Unit |
|------------------|-------------------------------|-------------------------------------------------------------------------------------------------------|-------------------------------------|--------------------|-----|--------------------------------------|-----|------|
|                  |                               |                                                                                                       | Min                                 | Typ <sup>[1]</sup> | Max | Min                                  | Max |      |
| t <sub>en</sub>  | enable time                   | n $\overline{\text{OE}}$ to nY; see <a href="#">Figure 7</a> <sup>[2]</sup>                           |                                     |                    |     |                                      |     |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                                               | -                                   | 40                 | 115 | -                                    | 135 | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                                               | -                                   | 11                 | 23  | -                                    | 27  | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                                               | -                                   | 8                  | 20  | -                                    | 23  | ns   |
| t <sub>dis</sub> | disable time                  | n $\overline{\text{OE}}$ to nY; see <a href="#">Figure 7</a> <sup>[2]</sup>                           |                                     |                    |     |                                      |     |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                                               | -                                   | 24                 | 125 | -                                    | 150 | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                                               | -                                   | 12                 | 25  | -                                    | 30  | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                                               | -                                   | 10                 | 21  | -                                    | 26  | ns   |
| t <sub>t</sub>   | transition time               | see <a href="#">Figure 6</a> <sup>[2]</sup>                                                           |                                     |                    |     |                                      |     |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                                               | -                                   | 18                 | 75  | -                                    | 90  | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                                               | -                                   | 6                  | 15  | -                                    | 18  | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                                               | -                                   | 5                  | 13  | -                                    | 15  | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | per buffer; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[3]</sup>                                    |                                     |                    |     |                                      |     |      |
|                  |                               | output enabled                                                                                        | -                                   | 11                 | -   | -                                    | -   | pF   |
|                  |                               | output disabled                                                                                       | -                                   | 1                  | -   | -                                    | -   | pF   |
| 74HCT2G125       |                               |                                                                                                       |                                     |                    |     |                                      |     |      |
| t <sub>pd</sub>  | propagation delay             | nA to nY; see <a href="#">Figure 6</a> <sup>[2]</sup>                                                 |                                     |                    |     |                                      |     |      |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                                               | -                                   | 15                 | 31  | -                                    | 38  | ns   |
|                  |                               | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF                                                       | -                                   | 12                 | -   | -                                    | -   | ns   |
| t <sub>en</sub>  | enable time                   | n $\overline{\text{OE}}$ to nY; see <a href="#">Figure 7</a> ; V <sub>CC</sub> = 4.5 V <sup>[2]</sup> | -                                   | 15                 | 35  | -                                    | 42  | ns   |
| t <sub>dis</sub> | disable time                  | n $\overline{\text{OE}}$ to nY; see <a href="#">Figure 7</a> ; V <sub>CC</sub> = 4.5 V <sup>[2]</sup> | -                                   | 15                 | 31  | -                                    | 38  | ns   |
| t <sub>t</sub>   | transition time               | see <a href="#">Figure 6</a> ; V <sub>CC</sub> = 4.5 V <sup>[2]</sup>                                 | -                                   | 6                  | 15  | -                                    | 18  | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | per buffer; V <sub>I</sub> = GND to V <sub>CC</sub> − 1.5 V <sup>[3]</sup>                            |                                     |                    |     |                                      |     |      |
|                  |                               | output enabled                                                                                        | -                                   | 11                 | -   | -                                    | -   | pF   |
|                  |                               | output disabled                                                                                       | -                                   | 1                  | -   | -                                    | -   | pF   |

[1] All typical values are measured at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  
 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .  
 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .  
 $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

12. Waveforms and test circuit

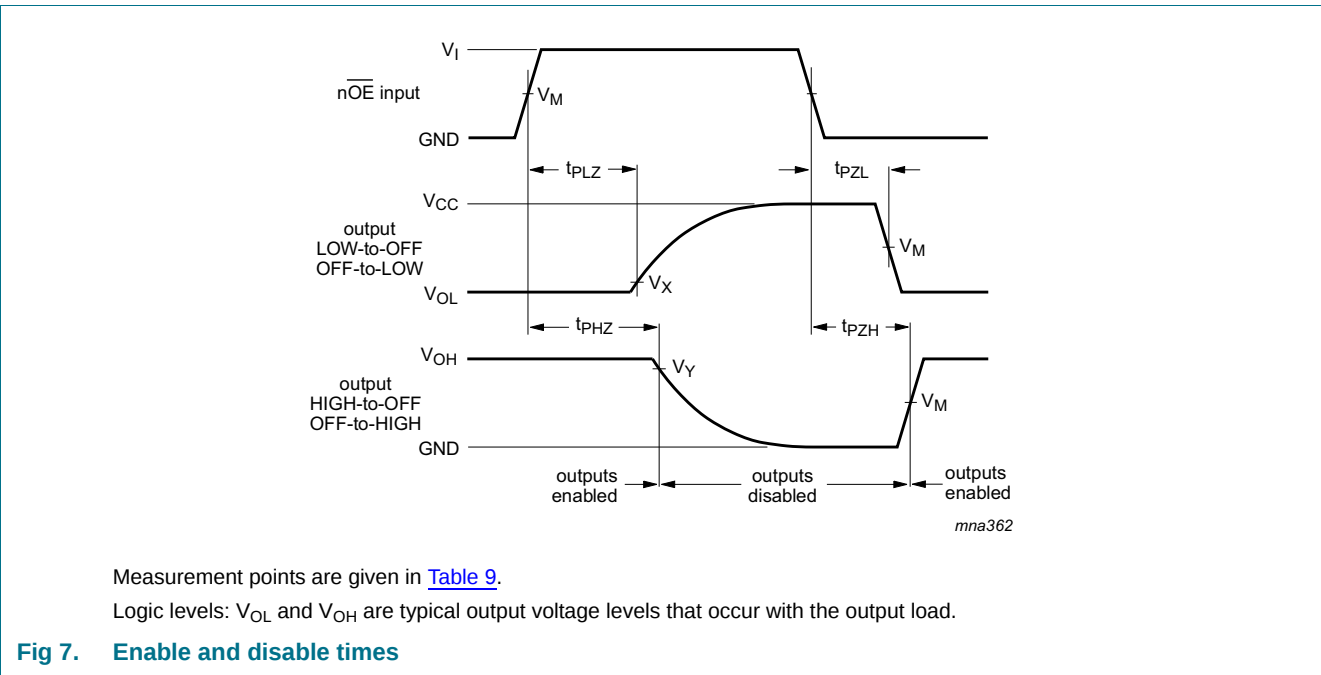
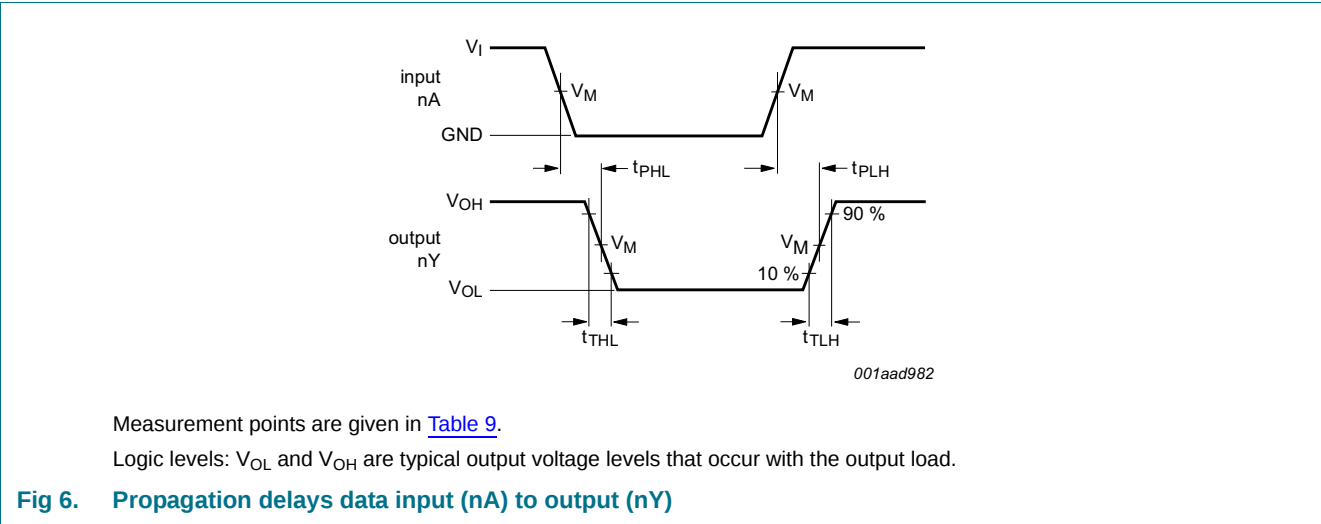


Table 9. Measurement points

| Type       | Input              | Output             |                         |                         |
|------------|--------------------|--------------------|-------------------------|-------------------------|
|            | $V_M$              | $V_M$              | $V_X$                   | $V_Y$                   |
| 74HC2G125  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> | V <sub>OL</sub> + 0.3 V | V <sub>OH</sub> - 0.3 V |
| 74HCT2G125 | 1.3 V              | 1.3 V              | V <sub>OL</sub> + 0.3 V | V <sub>OH</sub> - 0.3 V |

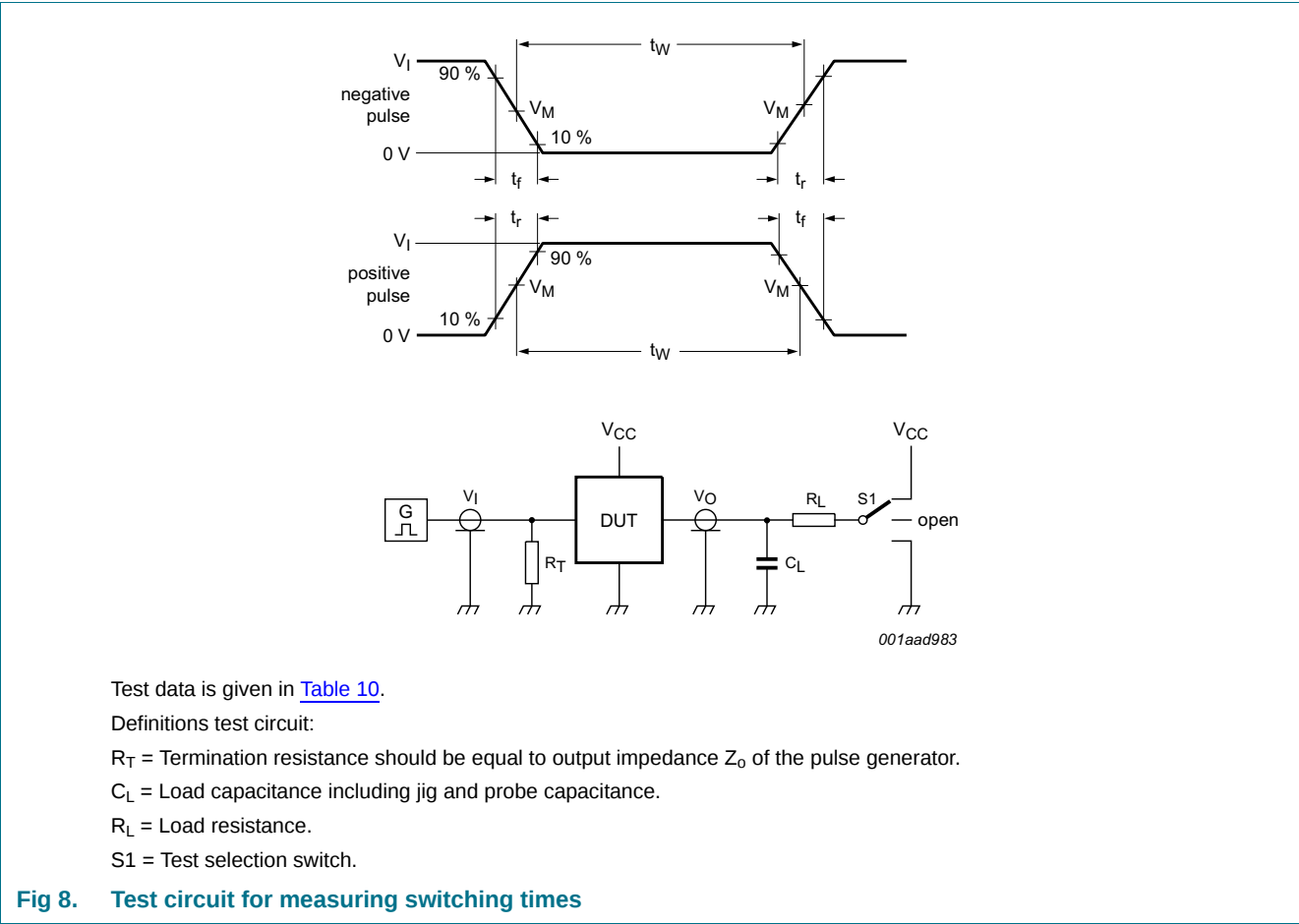


Table 10. Test data

| Type       | Input    |                     | Load         |              | S1 position        |                    |                    |
|------------|----------|---------------------|--------------|--------------|--------------------|--------------------|--------------------|
|            | $V_I$    | $t_r, t_f$          | $C_L$        | $R_L$        | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74HC2G125  | $V_{CC}$ | $\leq 6 \text{ ns}$ | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |
| 74HCT2G125 | 3 V      | $\leq 6 \text{ ns}$ | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |

13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm    SOT505-2

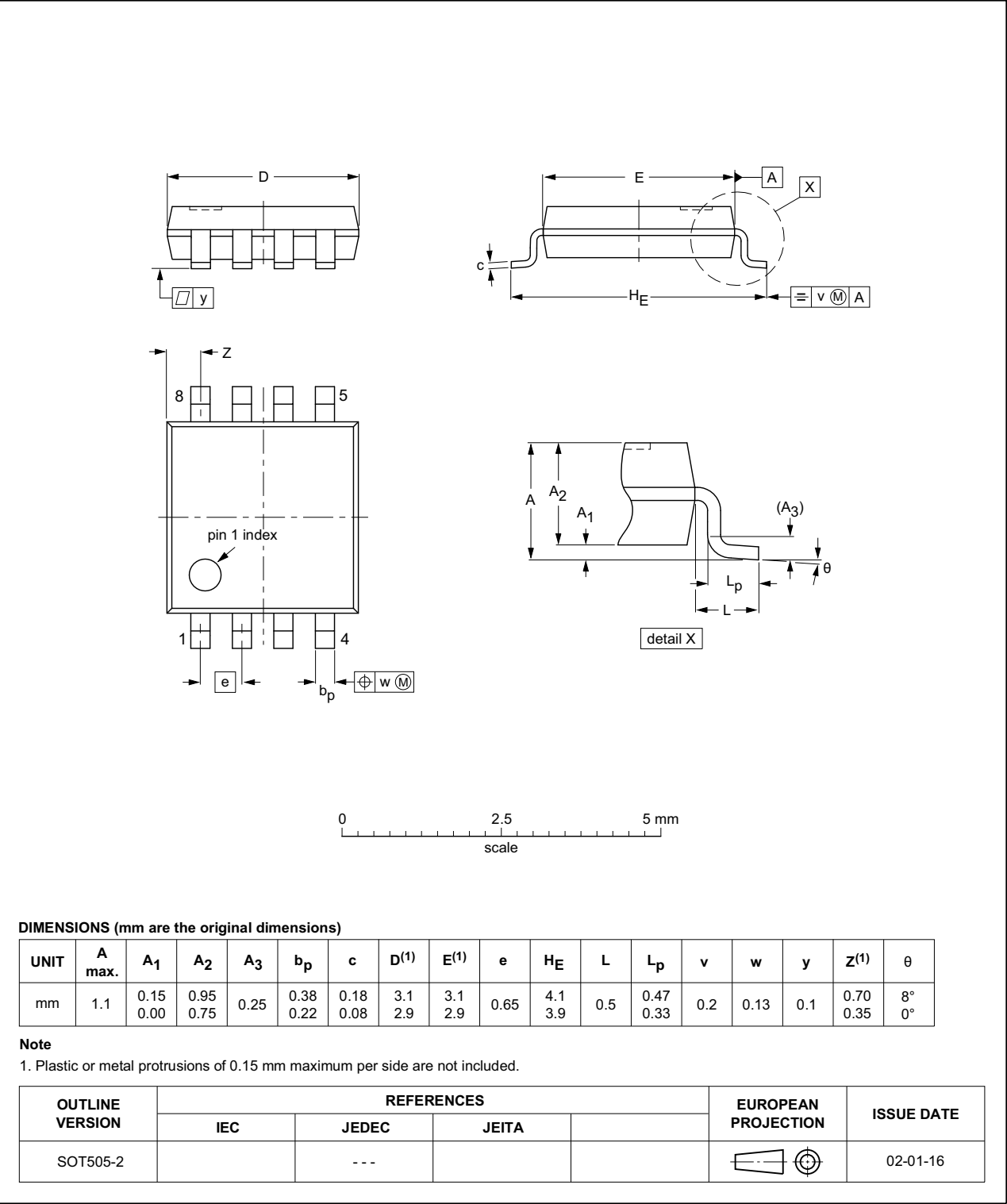


Fig 9. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

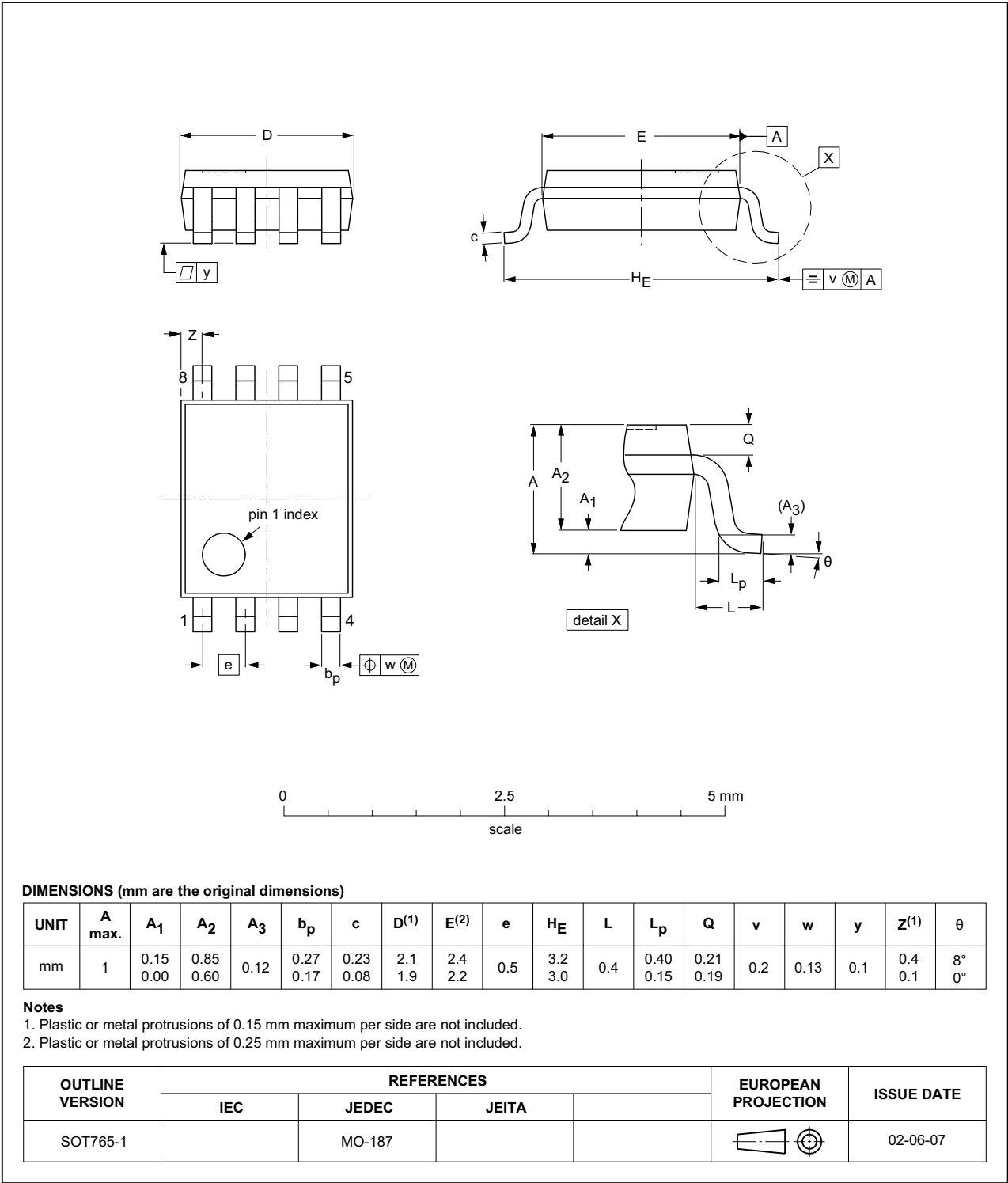


Fig 10. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads;  
8 terminals; body 3 x 2 x 0.5 mm

SOT996-2

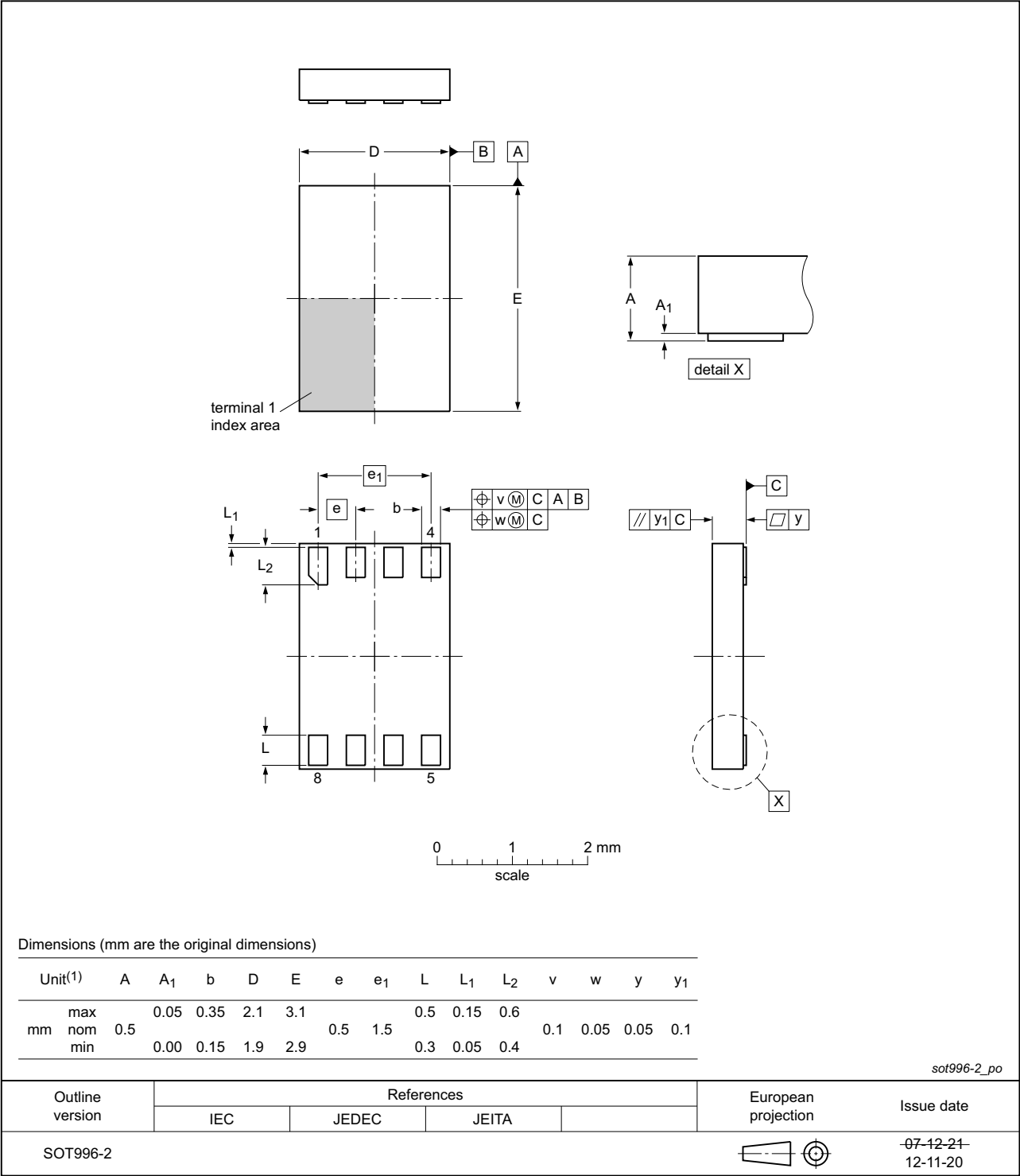


Fig 11. Package outline SOT996-2 (XSON8)

## 14. Abbreviations

Table 11. Abbreviations

| Acronym | Description                             |
|---------|-----------------------------------------|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 15. Revision history

Table 12. Revision history

| Document ID       | Release date                                                                 | Data sheet status     | Change notice | Supersedes        |
|-------------------|------------------------------------------------------------------------------|-----------------------|---------------|-------------------|
| 74HC_HCT2G125 v.5 | 20140317                                                                     | Product data sheet    | -             | 74HC_HCT2G125 v.4 |
| Modifications:    | • For type numbers 74HC2G125GD and 74HCT2G125GD XSON8U has changed to XSON8. |                       |               |                   |
| 74HC_HCT2G125 v.4 | 20080704                                                                     | Product data sheet    | -             | 74HC_HCT2G125 v.3 |
| 74HC_HCT2G125 v.3 | 20060102                                                                     | Product data sheet    | -             | 74HC_HCT2G125 v.2 |
| 74HC_HCT2G125 v.2 | 20030303                                                                     | Product specification | -             | 74HC_HCT2G125 v.1 |
| 74HC_HCT2G125 v.1 | 20030131                                                                     | Product specification | -             | -                 |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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